



Material Composition Sheet

Product: GS9007ACTA
 Package Type: SOIC-8 taped (2500/reel)
 Manufacturer: Gennum Corporation

Date: 06-Dec-2006

Component	BOM	Weight of Component (mg)	Substance	Weight of Substance (mg)	Homogeneous Material	
					%	ppm
Chip		1.53	Al	0.01	0.65	6536
			Si	1.52	99.34	993464
			Sub-total:	1.53	99.99	1000000
Die Attach	84-1 LMISR4	0.14	Aromatic Amine	0.01	7.14	71429
			Epoxy Resin	0.02	14.28	142857
			Silver	0.11	78.57	785714
			Sub-total:	0.14	99.99	1000000
Lead Finish External		1.41	Pb	0.35	24.82	248227
			Sn	1.06	75.17	751773
			Sub-total:	1.41	99.99	1000000
Lead Finish Internal		0.19	Ag	0.19	100.00	1000000
			Sub-total:	0.19	100.00	1000000
Leadframe	Olin 194FH	24.26	Cu	23.65	97.48	974856
			Fe	0.57	2.34	23495
			P	0.01	0.04	412
			Zn	0.03	0.12	1237
			Sub-total:	24.26	99.98	1000000
Marking Ink	Wieder W238	0.00		0.00	0.00	0
			Sub-total:	0.00	0.00	0
Mold Compound	EME 6300H	46.13	Antimony Trioxide	1.38	2.99	29915
			BrominatedEpoxyResin	0.92	1.99	19944
			Carbon Black	0.14	0.30	3035
			Epoxy Cresol Novolac	7.38	15.99	159983
			Phenol/Novolac resin	2.63	5.70	57013
			Silica Fused	33.68	73.01	730111
			Sub-total:	46.13	99.98	1000001
Wires	SGA3	0.21	Au	0.21	100.00	1000000
			Sub-total:	0.21	100.00	1000000
Total:		73.87				

GENNUM CORPORATION

Mailing Address: P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3
 Shipping Address: 970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5
 Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

www.gennum.com

The information contained in this document describes the homogeneous material composition of this product according to the definition set forth in the EU RoHS Directive 2002/95/EC. This information may have been derived from calculations based on information obtained from our suppliers. Gennum Corporation assumes no liability for any errors or omissions in this document. Gennum reserves the right to make changes to this document at any time without notice.